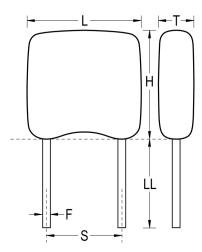


HP08BN104JC

HP LDD Indust COG HT200C, Ceramic, 0.1 uF, 5%, 50 VDC, COG, High Temperature, Lead Spacing = 10.16mm



Click here for the 3D model.

Dimensions	,
L	12.7mm MAX
Н	12.7mm MAX
Т	6.35mm MAX
S	10.16mm +/-0.762mm
LL	3.175mm MIN
F	0.635mm +0.102/-0.051mm

Packaging Specifications		
Packaging	Waffle, Tray	
Packaging Quantity	28	

General Information			
Series	HP LDD Indust COG HT200C		
Style	Radial		
Description	High Temperature		
Features	LDD High Temperature 200C		
RoHS	No		
Prop 65	▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.		
SCIP Number	2bf4ca06-62fe-49f4-aa96-4c1a95ccca94		
Termination	Copper		
Failure Rate	N/A		
AEC-Q200	No		

Specifications			
Capacitance	0.1 uF		
Measurement Condition	1 kHz 1.0Vrms		
Capacitance Tolerance	5%		
Voltage DC	50 VDC		
Dielectric Withstanding Voltage	125 VDC		
Temperature Range	-55/+200°C		
Temperature Coefficient	COG		
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±30 ppm/C, 1kHz 1.0Vrms		
Dissipation Factor	0.15% 1 kHz 1.0Vrms		
Insulation Resistance	10 GOhms		

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价,库存,交付和生命周期等信息

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